

## **SiC JFET Division**

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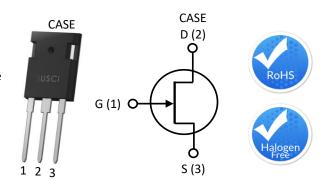
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#### Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 25 mohm UJ3N065025K3S

Datasheet

#### Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ( $R_{DS(ON)}$ ) and gate charge ( $Q_G$ ) allowing for low conduction and switching loss. The device normally-on characteristics with low  $R_{DS(ON)}$  at  $V_{GS}$  = 0 V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking		
UJ3N065025K3S	TO-247-3L	UJ3N065025K3S		

#### **Features**

- Typical on-resistance  $R_{DS(on),typ}$  of  $25m\Omega$
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- ◆ RoHS compliant
- AECQ Qualified

### **Typical Applications**

- Over current protection circuits
- DC-AC inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

#### **Maximum Ratings**

Parameter	Symbol	Test Conditions	Value	Units	
Drain-source voltage	V <sub>DS</sub>		650	V	
Cata assuma valta as	.,	DC	-20 to +3	N/	
Gate-source voltage	$V_{GS}$	AC <sup>(1)</sup>	-20 to +20	V	
(2)		T <sub>C</sub> = 25°C	85	А	
Continuous drain current (2)	I <sub>D</sub>	T <sub>C</sub> = 100°C	62	А	
Pulsed drain current <sup>(3)</sup>	I <sub>DM</sub>	T <sub>C</sub> = 25°C	250	А	
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25°C	441	W	
Maximum junction temperature	$T_{J,max}$		175	°C	
Operating and storage temperature	T <sub>J</sub> , T <sub>STG</sub>		-55 to 175	°C	
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>L</sub>		250	°C	

- (1) +20V AC rating applies for turn-on pulses <200ns applied with external  $R_G > 1\Omega$ .
- (2) Limited by T<sub>J,max</sub>
- (3) Pulse width t<sub>p</sub> limited by T<sub>J,max</sub>



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## Electrical Characteristics (T<sub>J</sub> = +25°C unless otherwise specified)

## **Typical Performance - Static**

Parameter	Cumbal	Test Conditions	Value			Units	
ratameter	Symbol	rest conditions	Min	Тур	Max	Units	
Drain-source breakdown voltage	BV <sub>DS</sub>	$V_{GS}$ = - 20V, $I_D$ =1mA	650			V	
Total drain leakage current	I <sub>D</sub>	$V_{DS} = 650V$ , $V_{GS} = -20V$ , $T_{J} = 25$ °C		10	60	- μΑ	
Total drain leakage cultent		V <sub>DS</sub> = 650V, V <sub>GS</sub> = -20V, T <sub>J</sub> = 175°C		40			
Total gate leakage current	I <sub>G</sub>	V <sub>GS</sub> =-20V, T <sub>j</sub> =25°C		10	100	μА	
Total gate leakage culterit		V <sub>GS</sub> =-20V, T <sub>j</sub> =175°C		38			
		$V_{GS}=2V, I_{D}=20A,$ $T_{J}=25^{\circ}C$		22		- mΩ	
Drain-source on-resistance	R <sub>DS(on)</sub>	$V_{GS}$ =0V, $I_D$ =20A, $T_J$ = 25°C		25	33		
Dialii-source off-resistance		$V_{GS}=2V, I_{D}=20A,$ $T_{J}=175^{\circ}C$		38			
		$V_{GS}$ =0V, $I_{D}$ =20A, $T_{J}$ = 175°C		43			
Gate threshold voltage	V <sub>G(th)</sub>	$V_{DS} = 5V, I_{D} = 70mA$	-14	-11.5	-6	V	
Gate resistance	$R_{G}$	f = 1MHz, open drain		2.5		Ω	

Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 25 mohm| UJ3N065025K3S

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## **Typical Performance - Dynamic**

Darameter	symbol	Test Conditions	Value			Units	
Parameter	Syllibol	rest conditions	Min	Тур	Max	Ullits	
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 100V,		2360		pF	
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> = -20V,		290			
Reverse transfer capacitance	C <sub>rss</sub>	f = 100kHz		282			
Effective output capacitance, energy related	C <sub>oss(er)</sub>	$V_{DS} = 0V \text{ to } 400V,$ $V_{GS} = -20V$		210		pF	
Total gate charge	$Q_{G}$	V 400V I 60A		240		nC	
Gate-drain charge	$Q_{GD}$	$V_{DS}$ =400V, $I_{D}$ = 60A, $V_{GS}$ =-18V to 0V		134			
Gate-source charge	$Q_{GS}$	V <sub>GS</sub> 18V tO OV		24			
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DS</sub> =400V, I <sub>D</sub> =60A, Gate Driver =-18V to 0V,		11		ns	
Rise time	t <sub>r</sub>			64			
Turn-off delay time	t <sub>d(off)</sub>			43			
Fall time	t <sub>f</sub>	$R_{G,EXT} = 1\Omega,$ Inductive Load,		44			
Turn-on energy	E <sub>ON</sub>	FWD: UJ3D06530TS		740		μ	
Turn-off energy	E <sub>OFF</sub>	T <sub>J</sub> = 25°C		818			
Total switching energy	E <sub>TOTAL</sub>			1558			
Turn-on delay time	t <sub>d(on)</sub>			11			
Rise time	t <sub>r</sub>	$V_{DS}$ =400V, $I_{D}$ =60A, Gate Driver =-18V to 0V, $R_{G,EXT}$ = $1\Omega$ , Inductive Load, FWD: UJ3D06530TS		62		- ns -	
Turn-off delay time	t <sub>d(off)</sub>			38			
Fall time	t <sub>f</sub>			41			
Turn-on energy	E <sub>ON</sub>			663			
Turn-off energy	E <sub>OFF</sub>	T <sub>J</sub> = =150°C		750		μͿ	
Total switching energy	E <sub>TOTAL</sub>			1413			

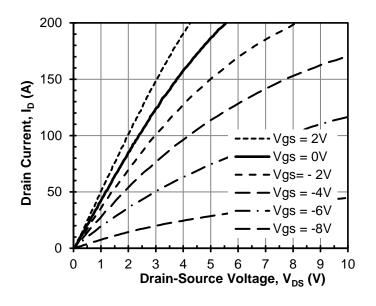
#### **Thermal Characteristics**

Parameter	symbol	Test Conditions	Value			Units
			Min	Тур	Max	Offics
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.26	0.34	°C/W

3



#### **Typical Performance Diagrams**



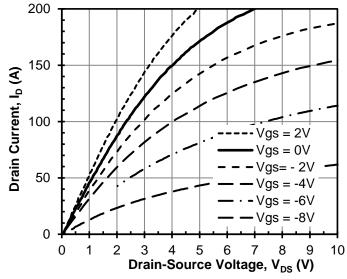
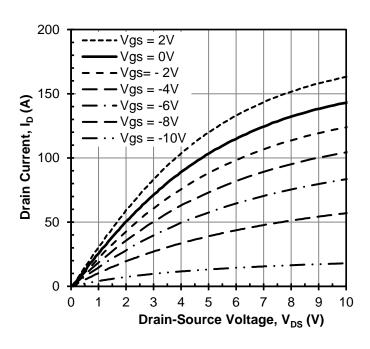
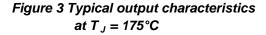


Figure 1 Typical output characteristics at  $T_J = -55$ °C

Figure 2 Typical output characteristics at  $T_J = 25$ °C





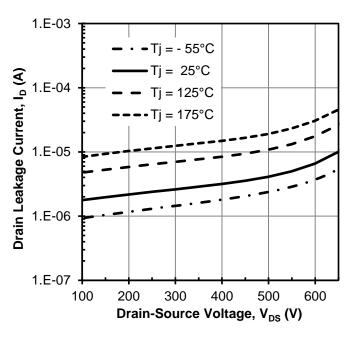


Figure 4 Typical drain-source leakage at  $V_{GS} = -20V$ 

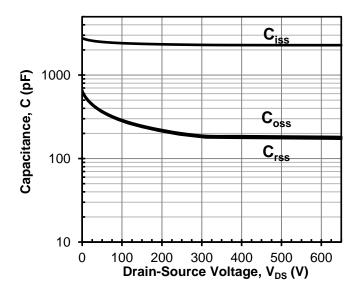


Figure 5 Typical capacitances at 100kHz and  $V_{GS} = -20V$ 

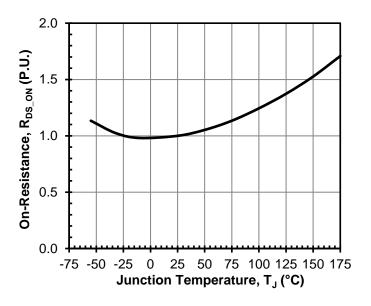


Figure 7 Normalized on-resistance vs. temperature at  $V_{GS} = 0V$  and  $I_D = 20A$ 

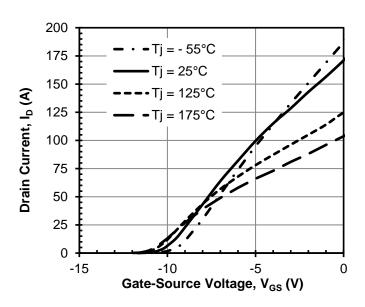


Figure 6 Typical transfer characteristics at  $V_{DS} = 5V$ 

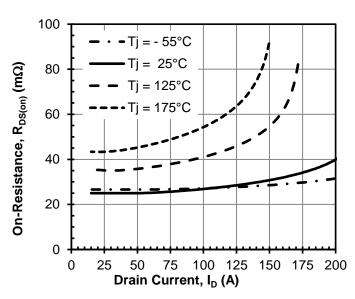


Figure 8 Typical drain-source on-resistance at  $V_{GS} = 0V$ 



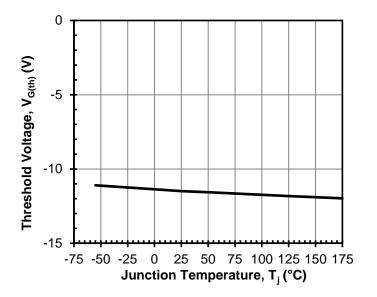


Figure 9 Threshold voltage vs. Tj at  $V_{DS} = 5V$  and  $I_D = 70mA$ 

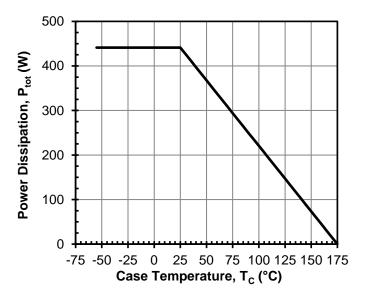


Figure 11 Total power Dissipation

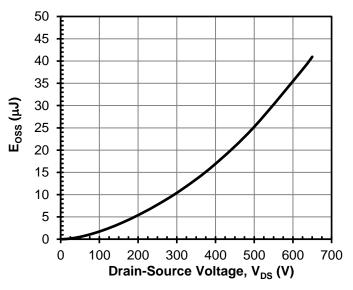


Figure 10 Typical stored energy in  $C_{OSS}$ at  $V_{GS} = -20V$ 

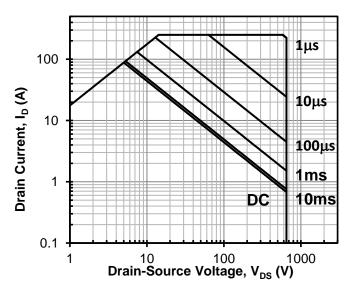


Figure 12 Safe operation area  $T_c = 25$ °C, Parameter  $t_p$ 



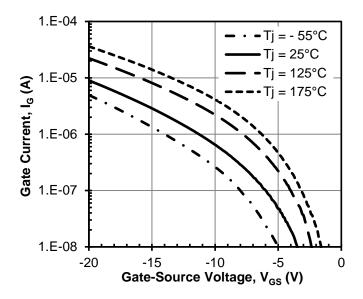


Figure 13 Typical gate leakage current at  $V_{DS} = 0V$ 

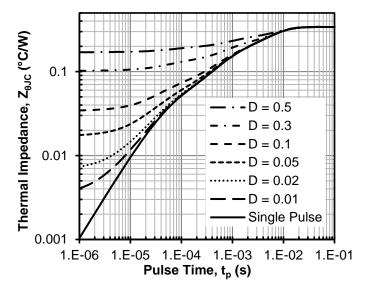


Figure 15 Maximum transient thermal impedance

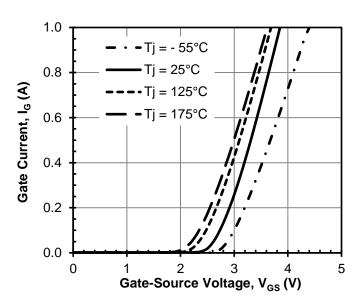


Figure 14 Typical gate forward current at  $V_{DS} = 0V$ 

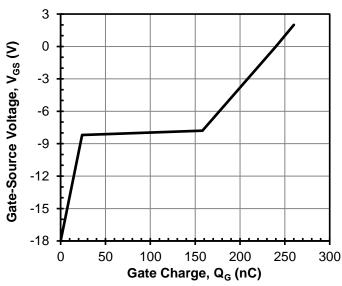
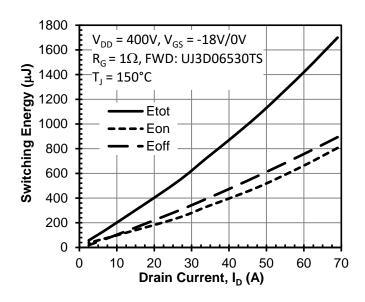


Figure 16 Typical gate charge at  $V_{DS} = 400V$  and  $I_D = 60A$ 





4500  $V_{DD} = 400V, V_{GS} = -18V/0V$ 4000 I<sub>D</sub> =60A, T<sub>I</sub> = 150°C Switching Energy (µJ 3500 FWD: UJ3D06530TS - Etot 3000 Eon 2500 Eoff 2000 1500 1000 500 0 2 10 8 0 Gate Resistor,  $R_{G}(\Omega)$ 

Figure 17 Clamped inductive switching energy vs. drain current at  $T_J = 150$ °C

Figure 18 Clamped inductive switching energy vs. gate resistor R<sub>G</sub>

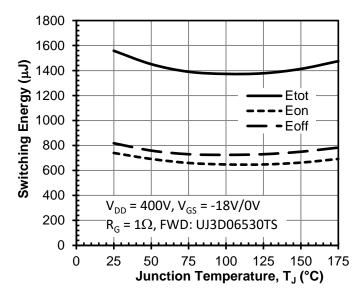


Figure 19 Clamped inductive switching energy vs. junction temperature at  $I_D = 60A$ 

Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 25 mohm | UJ3N065025K3S

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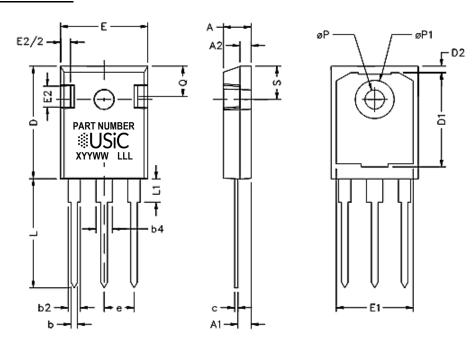
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# TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

## **PACKAGE OUTLINE**

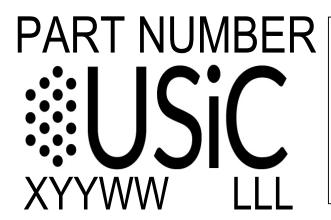


SYM	INC	HES	MILLIMETERS		
	MIN	MAX	MIN	MAX	
А	0.185	0.209	4.699	5.309	
A1	0.087	0.102	2.21	2.61	
A2	0.059	0.098	1.499	2.489	
b	0.039	0.055	0.991	1.397	
b2	0.065	0.094	1.651	2.388	
b4	0.102	0.135	2.591	3.429	
С	0.015	0.035	0.381	0.889	
D	0.819	0.845	20.803	21.463	
D1	0.515	-	13.081	-	
D2	0.02	0.053	0.508	1.346	
E	0.61	0.64	15.494	16.256	
е	0.214	4 BSC	5.44 BSC		
E1	0.53	-	13.462	-	
E2	0.135	0.157	3.429	3.988	
L	0.78	0.8	19.812	20.32	
L1	-	0.177	ı	4.496	
ØΡ	0.14	0.144	3.556	3.658	
ØP1	0.278	0.291	7.061	7.391	
Q	0.212	0.244	5.385	6.198	
S	0.243	3 BSC	6.17 BSC		



## TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

#### **PART MARKING**



PART NUMBER = REFER TO
DS PN DECODER FOR DETAILS

X = ASSEMBLY SITE

YY = YEAR

WW = WORK WEEK

LLL = LOT ID

#### PACKING TYPE

**ANTI-STATIC TUBE** 

**QUANTITY /TUBE: 30 UNITS** 

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